

Solidigm™ D7-P5810

SLC SSD

High Performance and Extreme-Write Workloads with Solidigm™ D7-P5810

Data is highly valuable to organizations as they undergo digital transformation. Yet enterprises are struggling to keep up with ever-increasing dataset sizes using their current data center and cloud infrastructures. They need fast and cost-efficient storage solutions for all of their data workloads. But one SSD does not fit all usages.

Enterprises need to consider the types of workloads they are running and adjust their storage accordingly. While quad-level cell (QLC) drives are well suited for many mainstream and read-intensive workloads, such as data lakes for artificial intelligence (AI), machine learning (ML), and content-delivery networks (CDNs), the storage needs of write-intensive workloads, such as high-frequency trading, caching, and databases, are quite different. These write loads are continuous and slower than read-intensive workloads, requiring a solution that helps improve response times.

Solidigm D7-P5810: Made for extreme writes and endurance

The Solidigm D7-P5810 is a single-level cell (SLC) NVMe Express (NVMe) drive that delivers what enterprises need for extremely write-heavy workloads like caching, high-performance computing (HPC), logging, and journaling, with nearly 2x better performance, compared to a Micron drive.¹ It also offers high random and sequential write durability at an endurance rate of up to 50 drive writes per day (DWPD) for random write workloads.

Along with high endurance and performance, the D7-P5810 operates with lower power consumption compared to storage-class memory alternatives. Its power rating is 10 W active and 5 W idle, which is 17 percent and 34 percent lower than comparable Micron and KIOXIA drives, respectively.^{2,3,4}

Optimized for industry-leading write performance, endurance, and power efficiency							
Product	SR 128K QD32	SW 128K QD32	RR 4K (see QD)	RW 4K (see QD)	70R/30W 4K QD128	Endurance 100% 4 KB RW DWPD	Power Active/idle
D7-P5810 ² 800 GB	0.94x Up to 6,400 MB/s	0.83x Up to 4,400 MB/s	1x Up to 900K IOPS (QD128)	1.98x Up to 495K IOPS (QD128)	1.17x Up to 645K IOPS	1.43x 50 DWPD	0.83x 10 W/5 W (lower is better)
Micron XTR ³ 960 GB	1x Up to 6,800 MB/s	1x Up to 5,300 MB/s	1x Up to 900K IOPS (QD256)	1x Up to 250K IOPS (QD128)	1x Up to 550K IOPS	1x 35 DWPD	1x 12 W/5 W (lower is better)
KIOXIA FL6 ⁴ 800 GB	0.91x Up to 6,200 MB/s	1.17x Up to 6,200 MB/s	1.64x Up to 1.48M IOPS (QD256)	1.44x Up to 360K IOPS (QD128)	Not applicable (N/A)	1.71x 60 DWPD	1.17x 14 W/5 W (lower is better)

Use cases

As an SLC drive, the D7-P5810 supports several use cases:

- **An acceleration layer:** Placing performance-sensitive data such as metadata or logs on the D7-P5810 can accelerate system performance for database applications.
- **As cache:** The D7-P5810 can be used as cache or a write buffer to remove performance bottlenecks and dramatically improve total cost of ownership (TCO) for hyperconverged infrastructure (HCI) applications.
- **For tiering:** Intelligently store the hottest data in SLC. Colder data can be aggregated, compressed, and written in bulk to underlying QLC SSDs.

Role as a persistent write buffer

The D7-P5810 can also be used with QLC drives in a cloud storage acceleration layer (CSAL) deployment. A CSAL is an open-source software layer that uses storage-class media as a write cache to shape write workloads in all forms and sizes (large, small, random, and sequential) to NAND-friendly, large input/output (I/O) sequential writes. This can greatly improve the performance and lifetime of QLC SSDs. As shown in Figure 1, the D7-P5810 can act as the ultra-fast write buffer for a CSAL to sequentialize I/O writes to a QLC device.

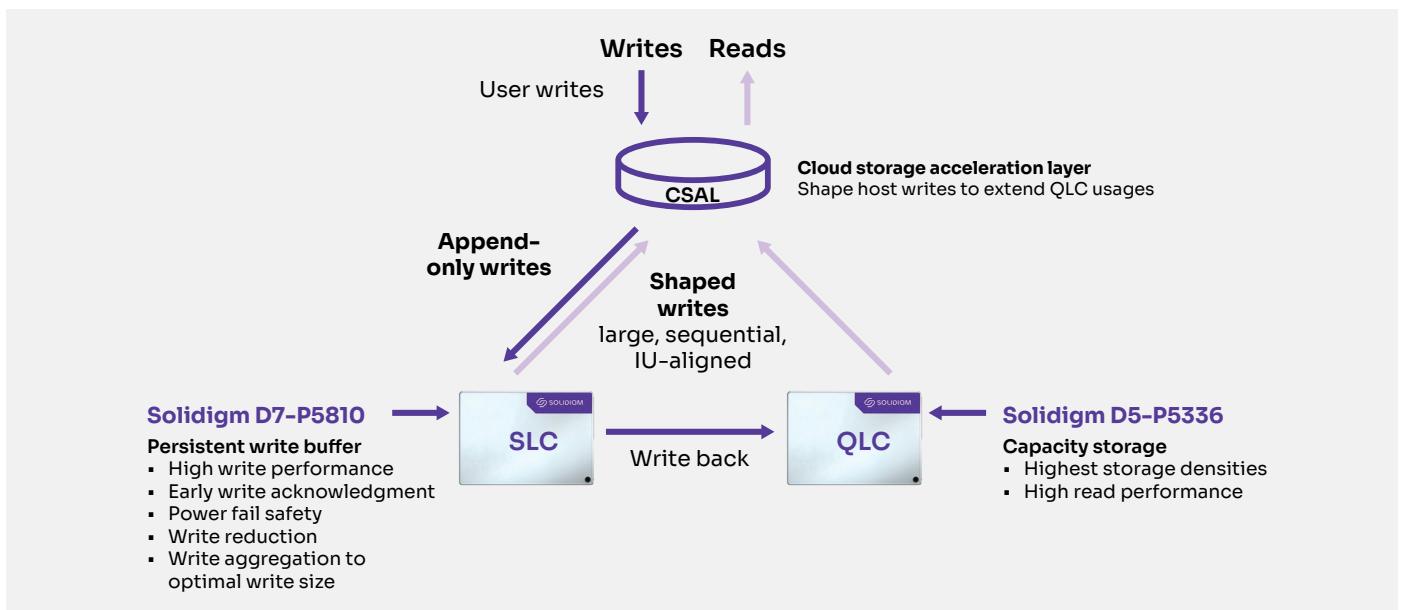


Figure 1. The Solidigm D7-P5810 can be used as a persistent write buffer as part of a CSAL

Solidigm D7-P5810 key feature overview

Form factor	U.2 (15 mm)
Media	144L3D NAND
Bus	PCIe 4.0
User capacity	800 GB
Endurance (five-year DWPD)	50 DWPD
Endurance (PB written [PBW])	73 PBW
Maximum power	~10 W
Idle power	<5 W
Uncorrectable bit error rate (UBER)	<1 sector per 10^{17} bits read ⁵
Mean time between failures (MTBF)	2 million hours
4K random read, I/O operations per second (IOPS), queue depth 256 (QD256)	865K
4K random, write IOPS, QD256	495K
128K sequential read, MB/s, QD32	6,400 MB/s
128K sequential write, MB/s, QD32	4,400 MB/s
Other features	NVMe 1.4 and NVMe MI 1.1 compliant

Deploy with confidence

Solidigm believes the two basic requirements of any storage device are to always be available and to never return bad data. While no storage solution can provide an absolute guarantee that these requirements are met, Solidigm applies its decades of experience and its industry-wide deep technical engagements to relentlessly pursue these goals.

It starts with design, where Solidigm adds extra checks into its power-loss protection to help ensure data is saved accurately. In addition, Solidigm delivers highly robust full data-path protection with error correction code (ECC) covering 99 percent of SRAM. From there, the company conducts test and validation procedures that go above and beyond industry specifications and common practices, such as testing for 10x and beyond UBER ratings and the JEDEC specification. This thoughtfulness pays off when considering results such as an annualized failure rate (AFR) in high-volume manufacturing that is consistently better than the company's ≤0.44 percent goal. In addition, through testing for resistance to silent data corruption (SDC) at Los Alamos National Labs spanning five product generations and more than 6 million cumulative years of simulated drive life, Solidigm has shown zero SDC events.



¹ Measuring 4K random write IOPS performance at QDI28 versus a 960 GB Micron XTR NVMe SSD. Source: Micron. “Micron® XTR NVMe™ SSD.” May 2023. https://media-www.micron.com/-/media/client/global/documents/products/product-flyer/xtr_nvme_ss_product_brief.pdf?la=en&rev=1804383771b74425b1ad2546c6b7db20.

² Solidigm D7-P5810 data sheet, to be published.

³ Micron. “Micron XTR SSD Series Technical Product Specification.” June 2023. https://media-www.micron.com/-/media/client/global/documents/products/technical-marketing-brief/xtr_ss_tech_prod_spec.pdf?la=en&rev=2705d6833ae447619adf884c5bed9084.

⁴ KIOXIA. “KIOXIA FL6 Series.” 2023. <https://americas.kioxia.com/content/dam/kioxia/shared/business/ssd/enterprise-ssd/asset/productbrief/eSSD-FL6-product-brief.pdf>.

⁵ UBER rating tested to 10x higher than the JEDEC specification. Solidigm tests to 1E-17 under a full range of conditions and cycle counts throughout the life of the drive, which is 10x higher than 1E-16 specified in the JEDEC Solid State Drive Requirements and Endurance Test Method (JESD21B). Source: JEDEC. Solid State Drives webpage. Accessed September 2023. www.jedec.org/standards-documents/focus/flash/solid-state-drives. SDC rating modeled to 1E-25. Typical reliability demonstration tests involve 1K SSDs for 1K hours to model to 1E-18. Solidigm drives are tested at the neutron source at Los Alamos National Labs to measure SDC susceptibility to 1E-23 and modeled to 1E-25.

Current characterized errata are available on request.

Contact your Solidigm representative or your distributor to obtain the latest specifications before placing your product order.

For copies of this document, documents that are referenced within, or other Solidigm literature, please contact your Solidigm representative.

All products, computer systems, dates, and figures specified are preliminary based on current expectations, and are subject to change without notice.

© Solidigm. “Solidigm” is a trademark of SK hynix NAND Product Solutions Corp (d/b/a Solidigm). Other names and brands may be claimed as the property of others.